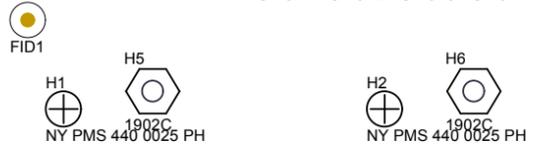
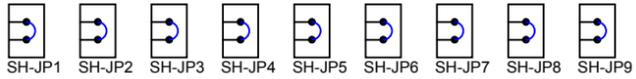
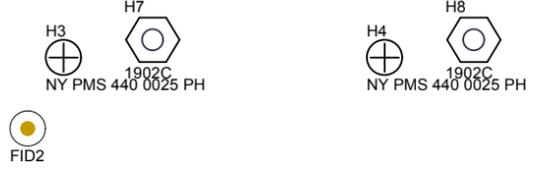


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PCB Number: PMP9753  
PCB Rev: A

PCB  
LOGO  
Texas Instruments



LBL1  
PCB Label  
Size: 0.65" x 0.20"

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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Designed for: <a href="#">Public Release</a>		Mod. Date: 7/22/2014	
Project Title: <a href="#">Energy Buffering</a>			
Sheet Title: <a href="#">Hardware</a>			
Number: <a href="#">PMP9753</a>	Rev: <a href="#">A</a>	Assembly Variant: <a href="#">[No Variations]</a>	Sheet: <a href="#">2</a> of <a href="#">2</a>
SVN Rev: <a href="#">Not in version control</a>	File: <a href="#">PMP9753_SUPERCAP_Hardware.SchDoc</a>	Size: <a href="#">B</a>	<a href="#">http://www.ti.com</a>
Drawn By: <a href="#">Florian Feckl</a>	Contact: <a href="#">http://www.ti.com/support</a>	<a href="#">http://www.ti.com</a>	
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